

INTERNATIONAL STANDARD

**OPC Unified architecture –
Part 21: Device Onboarding**

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OPC unified architecture - Part 21: Device Onboarding

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The text of this International Standard is based on the following documents:

Draft	Report on voting
65E/1046/CDV	65E/1103/RVC

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/publications.

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The *italicized terms* and *names* are also often written in camel-case (the practice of writing compound words or phrases in which the elements are joined without spaces, with each element's initial letter capitalized within the compound). For example, the defined term is *AddressSpace* instead of Address Space. This makes it easier to understand that there is a single definition for *AddressSpace*, not separate definitions for Address and Space.

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